

## **Product Specification**

Part No.: SCD-017

1) Rating: DC 30V 0.3A

2) Operating Temperature Range:  $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$ 

## 3) Electrical Performance:

	Test Conditions	Performance
Contact Resistance	Measured at small current (10mA	50m $Ω$ Max.
	1000Hz or less)	
	Apply a voltage of 500V DC	
	shall be applied for 1 minute after	
	which measurement taken:	
	(1) Between terminals not to	
Insulation Resistance	be contact	100MΩ Min.
Insulation Resistance	(2) Between body and	
	terminal	
	(3) Between terminals not to	
	be contact when plug is	
	inserted	
Dielectric Strength	AC500V rms (50-60Hz) for 1	
	minute trip current: 0.5mA	
	(1) Between terminals not to	
	be contact.	Without demage to parts areing
	(2) Between body and	Without damage to parts arcing or breakdown
	terminal	
	(3) Between terminals not to	
	be contact when plug is	
	inserted.	

## 4) Mechanical Performance:

	Test Conditions	Performance
Insertion Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	500~1200 gf
Extraction Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	500~1200 gf
Terminal Strength	A static load of 150gf shall be applied to the terminal for 15 seconds in any direction	Electrical characteristics shall be satisfied without damage or excessive looseness of terminals
Life Test	Endurance without load: Jack shall be subjected to 5,000 cycles at a rate of 15 to 18 cycles per minute without loading.	<ul> <li>(1) Contact resistance: 100mΩ         Max.</li> <li>(2) Insulation Resistance: 50MΩ         Min.</li> <li>(3) Withstand Voltage: AC 500V</li> </ul>



	for 1 minute.  (4) Without damage to parts arcing or breakdown.
--	---

## 5) **Environmental Characteristics:**

5) Environmental Characteristics:				
	Test Conditions	Performance		
Solderability Test	The top of terminals shall be	The Area of soldering should be		
	dipped 2mm in the solder bath of	over 75%		
	230±5°C for 3±0.5 seconds			
Resistance to Solder Heat Test	Solder iron method:	Without deformation of case or		
	Temperature of solder 350±10°C.	excessive looseness of terminals		
	Time of solder 3±0.5 sec.	electrical characteristics shall be		
		satisfied.		
	The jack shall be stored at a			
	temperature of -25± 3°C for 48			
	hours, then the switch shall be			
Cold Test	maintained at standard			
	atmospheric conditions for 1 hour			
	after which measurement shall be			
	made	There shall be no deformation or		
	The jack shall be stored at a	cracks in the molded part.		
	temperature of 70±2°C for 48			
	hours, then the jack shall be			
Heat Test	maintained at standard			
	atmospheric conditions for 1 hour			
	after which measurement shall be			
	made.			
	The jack shall be stored at a			
	temperature of 40±2°C and a			
	humidity of 90% to 95% for 48			
Humidity Test	hours, then the jack shall be	There shall be no deformation or		
·	maintained at standard	cracks in molded part.		
	atmospheric conditions for 1 hour			
	after which measurement shall be			
	made.			
Te	st Condition (Unless otherwise specifi	ied)		
	Temperature: 5°C - 35°C			
	Humidity: 45% - 85% R.H.			
	D			

Pressure: 86 – 106kPa